



MATERIAL : BODY-SUS303
 CONTACT-BERYLLIUM COPPER
 INSULATOR-TEFLON
 FINISH : BODY-GOLD PLATING OVER NICKEL
 CONTACT-GOLD PLATING OVER NICKEL

DIMENSIONS ARE MILLIMETERS				SCHMID-M	
TOLERANCE					
• x	± 0.5	ANGLE ±3°	SCALE	5 : 1	
• x x	± 0.1		REV	A-0	
• x x x	± 0.05		DATE	91.10.25	
DRAWN		DATE		DRAWING NO	
APPROVAL		DATE		SMA-3204-TGG	
				FILE NO	